

SPECIFICATION FOR APPROVAL

() Preliminary Specification

(•) Final Specification

Title

75.0" QWUXGA TFT LCD

BUYER	
MODEL	

SUPPLIER	LG Display Co., Ltd.
*MODEL	LD750EQD
SUFFIX	FLM1 (RoHS Verified)

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RECORD OF REVISIONS

Revision No.	Revision Date	Page	Description
0.0	Nov, 14, 2017	-	Preliminary Specification (First Draft)
1.0	Mar. 03. 2018	6	Life time update (typ. 50,000 hrs)
		29	Portrait mode direction change (counter clock wise \rightarrow clock wise)
		3, 21	LCM weight update
		22,23	mechanical drawing update
		-	Final CAS

1. General Description

The LD750EQD is a Color Active Matrix Liquid Crystal Display with an integral Light Emitting Diode (LED) backlight system. The matrix employs a-Si Thin Film Transistor as the active element.

It is a transmissive display type which is operating in the normally black mode. It has a 74.52 inch diagonally measured active display area with QWUXGA resolution (2160 vertical by 3840 horizontal pixel array).

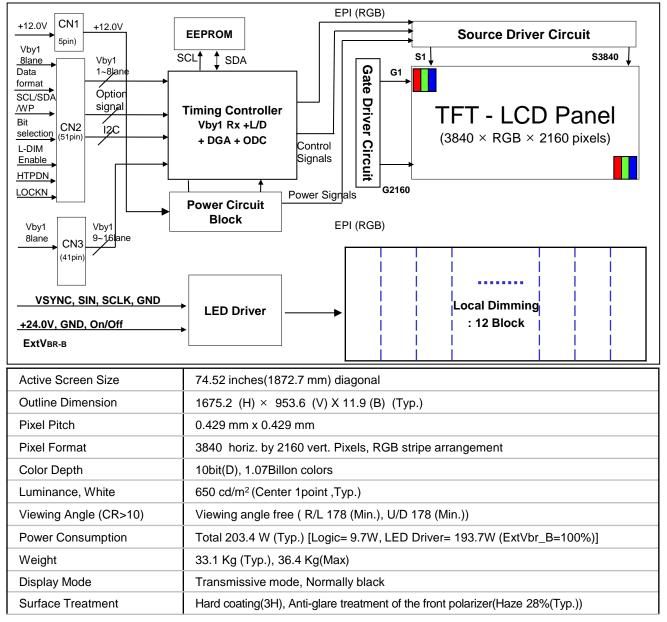
Each pixel is divided into Red, Green and Blue sub-pixels or dots which are arrayed in vertical stripes.

Gray scale or the luminance of the sub-pixel color is determined with a 10-bit gray scale signal for each dot.

Therefore, it can present a palette of more than 1.07Bilion colors.

It has been designed to apply the 10-bit 16 Lane V by One interface.

It is intended to support Commercial Display where high brightness, super wide viewing angle, high color gamut, high color depth and fast response time are important.



2. Absolute Maximum Ratings

The following items are maximum values which, if exceeded, may cause faulty operation or permanent damage to the LCD module.

Table 1.	ABSOLUTE	MAXIMUM	RATINGS
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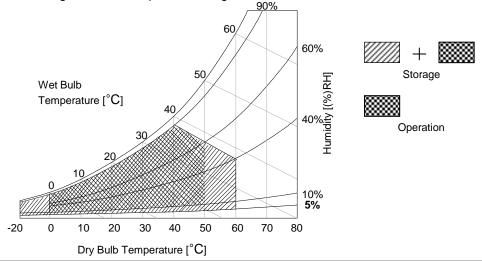
Dara	Parameter		Va	lue	Unit	Notes
Parameter		Symbol	Min	Max	Unit	
Power Input Veltage	LCD Circuit	VLCD	-0.3	+14.0	VDC	
Power Input Voltage	Driver	VBL	-0.3	+ 27.0	VDC	
	ON/OFF	Voff / Von	-0.3	+3.9	VDC	
Driver Control Voltage	Brightness	EXTVBR-B	-0.3	+3.9	VDC	1
	Status	Status	-0.3	+3.9	VDC	
T-Con Option Selection	Voltage	VLOGIC	-0.3	+4.0	VDC	
Operating Temperature		Тор	0	+50	°C	2.2
Storage Temperature		Tst	-20	+60	°C	2,3
Panel Front Temperature		TSUR	-	+68	°C	4
Operating Ambient Humidity		Нор	10	90	%RH	2.2
Storage Humidity		Нѕт	5	90	%RH	2,3

Notes 1. Ambient temperature condition (Ta = 25 ± 2 °C)

2. Temperature and relative humidity range are shown in the figure below.

Wet bulb temperature should be Max 39°C, and no condensation of water.

- 3. Gravity mura can be guaranteed below 40°C condition.
- 4. The maximum operating temperatures is based on the test condition that the surface temperature of display area is less than or equal to 68°C with LCD module alone in a temperature controlled chamber. Thermal management should be considered in final product design to prevent the surface temperature of display area from being over 68°C. The range of operating temperature may be degraded in case of improper thermal management in final product design.



3. Electrical Specifications

3-1. Electrical Characteristics

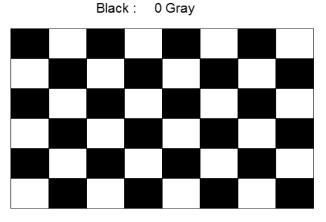
It requires two power inputs. One is employed to power for the LCD circuit. The other Is used for the LED backlight and LED Driver circuit.

Table 2. E	ELECTRICAL	CHARACTE	ERISTICS
------------	------------	----------	----------

Baram	Parameter			Value	Unit	notes	
Farain			Min	Тур	Max	Onit	notes
Circuit :							
Power Input Voltag	Power Input Voltage		10.8	12.0	13.2	VDC	
Power Input Currer	Davies land Current		-	810	1053	mA	1
		ILCD	-	2990	3887	mA	2
T-CON Option	Input High Voltage	V _{IH}	2.7	-	3.6	VDC	
Selection Voltage	Input Low Voltage	V _{IL}	0	-	0.7	VDC	
Power Consumption		PLCD	-	9.72	12.6	Watt	1
Rush current		IRUSH	-	-	8.0	A	3

notes

- 1. The specified current and power consumption are under the V_{LCD}=12.0V, Ta=25 \pm 2°C, f_V=120Hz condition, and mosaic pattern(8 x 6) is displayed and f_V is the frame frequency.
- 2. The current is specified at the maximum current pattern.
- 3. The duration of rush current is about 2ms and rising time of power input is 0.5ms (min.).
- 4. Ripple voltage level is recommended under $\pm 5\%$ of typical voltage



White : 1023 Gray

R	G	В	R	G	В	R	G	В	R	G	В
R	G	В	R	G	В	R	G	В	R	G	В
R	G	В	R	G	В	R	G	В	R	G	В
R	G	В	R	G	В	R	G	В	R	G	В
R	G	В	R	G	В	R	G	В	R	G	В
R	G	В	R	G	В	R	G	В	R	G	В
R	G	В	R	G	В	R	G	В	R	G	В
R	G	В	R	G	В	R	G	В	R	G	В

Mosaic Pattern(8 x 6)

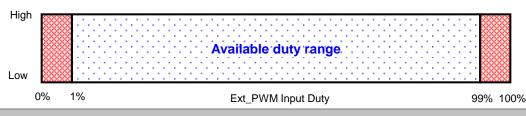
Max Current Pattern

Table 3. ELECTRICAL CHARACTERISTICS (Continue)

Parameter				Values					
Par	Parameter		Symbol	Min	Тур	Max	Unit	Notes	
LED Driver :									
Power Supply Inpu	t Voltage		VBL	21.6	24.0	26.4	Vdc	1	
Power Supply Input	Current		IBL	-	8.1	8.7	A	1	
Power Supply Input Current (In-Rush)		In-rush	_	_	16	A	VBL = 21.6V ExtVBR-B=100% 4		
Power Consumption (Total)		PBL	-	193.7	209.9	W	1		
	0-/04	On	V on	2.5	-	3.6	Vdc		
	On/Off	0n/Gn	Off	V off	-0.3	0.0	0.7	Vdc	
Input Voltage	Brightness	s Adjust	ExtVBR-B	1	-	100	%	On Duty 6	
for Control System Signals	PWM Freq	uency for	PAL		100		Hz	3	
, ,	NTSC & PAL		NTSC		120		Hz	3	
	Pulse Duty Level		HighLevel	2.5	-	3.6	Vdc	HIGH : on duty	
(PWM)		Low Level	0.0	-	0.7	Vdc	LOW: off duty		
LED :									
Life Time				30,000	50,000		Hrs	6	

Notes :

- Electrical characteristics are determined after the unit has been 'ON' and stable for approximately 60 minutes at 25±2°C. The specified current and power consumption are under the typical supply Input voltage 24Vand VBR (ExtVBR-B: 100%), it is total power consumption.
- 2. LGD recommend that the PWM freq. is synchronized with One time harmonic of V_sync signal of system. Though PWM frequency is over 120Hz (max 252Hz), function of LED Driver is not affected.
- 3. The duration of rush current is about 200ms. This duration is applied to LED on time
- 4. Even though inrush current is over the specified value, there is no problem if I²T spec of fuse is satisfied.
- Ext_PWM Signal have to input available duty range. Between 99% and 100% ExtVBR-B duty have to be avoided. (99% < ExtVBR-B < 100%) But ExtVBR-B 0% and 100% is possible.
- 6. The life time is determined as the time at which brightness of the LED is 50% compared to that of initial value at the typical LED current on condition of continuous operating at $25 \pm 2^{\circ}$ C, based on duty 100%.



3-2. Interface Connections

This LCD module employs theree kinds of interface connection, 5-pin connector, 51-pin connector and 41-pin connector are used for the module electronics and 14-pin,12-pin connector is used for the integral backlight system.

3-2-1. LCD Module

- LCD Connector(CN1): 20037WR-H05 (manufactured by YEONHO)

Table 4-1. MODULE CONNECTOR(CN1) PIN CONFIGURATION

No	Symbol	Description
1	GND	Ground
2	GND	Ground
3	VLCD	Power Supply +12.0V
4	VLCD	Power Supply +12.0V
5	VLCD	Power Supply +12.0V

- LCD Connector(CN1): FI-RXE51S-HF (manufactured by JAE) or compatible or GT05S-51S-H38 (manufactured by LSM) or IS050-C51B-C39-C(manufactured by UJU)

No	Symbol	Description	No	Symbol	Description
1	NC	No Connection(notes 2)		GND	Ground
2	NC	No Connection(notes 2)		Rx0n	V-by-One HS Data Lane 0
3	NC	No Connection(notes 2)	29	Rx0p	V-by-One HS Data Lane 0
4	NC	No Connection(notes 2)	30	GND	Ground
5	NC	No Connection(notes 2)	31	Rx1n	V-by-One HS Data Lane 1
6	NC	No Connection(notes 2)	32	Rx1p	V-by-One HS Data Lane 1
7	NC	No Connection(notes 2)	33	GND	Ground
8	NC	No Connection(notes 2)	34	Rx2n	V-by-One HS Data Lane 2
9	NC	No Connection	35	Rx2p	V-by-One HS Data Lane 2
10	GND	Ground	36	GND	Ground
11	GND	Ground	37	Rx3n	V-by-One HS Data Lane 3
12	GND	Ground	38	Rx3p	V-by-One HS Data Lane 3
13	GND	Ground	39	GND	Ground
14	GND	Ground	40	Rx4n	V-by-One HS Data Lane 4
15	Data format 0	Input Data Format [1:0] :	41	Rx4p	V-by-One HS Data Lane 4
16	Data format 1	'00'=Mode1, '01'=Mode2, '10'=Mode3, '11'=Mode4	42	GND	Ground
17	NC	No Connection (notes 4)	43	Rx5n	V-by-One HS Data Lane 5
18	NC	No Connection (notes 4)	44	Rx5p	V-by-One HS Data Lane 5
19	NC	No Connection (notes 4)	45	GND	Ground
20	NC	No Connection (notes 4)	46	Rx6n	V-by-One HS Data Lane 6
21	Bit SEL	'H' or NC= 10bit(D) , 'L' = 8bit	47	Rx6p	V-by-One HS Data Lane 6
22	L-DIM Enable	'H' or NC = Enable (Default On) 'L' = Disable	48	GND	Ground
23	AGP or NSB	['] H' or NC : AGP 'L' : NSB (No signal Black)	49	Rx7n	V-by-One HS Data Lane 7
24	GND	Ground	50	Rx7p	V-by-One HS Data Lane 7
25	HTPDN	Hot plug detect	51	GND	Ground
26	LOCKN	Lock detect	-	-	-

Table 4-2. MODULE CONNECTOR(CN2) PIN CONFIGURATION

notes

1. All GND (ground) pins should be connected together to the LCD module's metal frame.

2. #1~#8 NC (No connection) : These pins are used for back up power source, VLCD (power input) . These pins are should be connected together.

3. All Input levels of V-by-One signals are based on the V-by-One HS Standard Version 1.4

4. Specific pin (#22) is used for Local Dimming function of the LCD module. If not used, connect to GND.

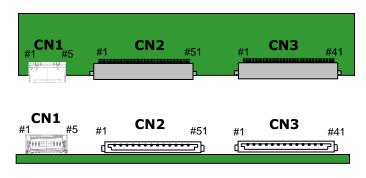
5. Specific pin No. **#23** is used for "No signal detection" of system signal interface.

It should be GND for NSB (No Signal Black) while the system interface signal is not. If this pin is "H" or "NC", LCD Module displays AGP (Auto Generation Pattern). - LCD Connector (CN2) : FI-RXE41S-HF (manufactured by JAE) or GT05S-41S-H38(manufactured by LSM) or IS050-C41B-C39-C(manufactured by UJU)

			-			
No	Symbol	Description		No	Symbol	Description
1	GND	Ground		22	GND	Ground
2	Rx8n	V-by-One HS Data Lane 8		23	Rx15n	V-by-One HS Data Lane 15
3	Rx8p	V-by-One HS Data Lane 8		24	Rx15p	V-by-One HS Data Lane 15
4	GND	Ground		25	GND	Ground
5	Rx9n	V-by-One HS Data Lane 9		26	NC	NO CONNECTION
6	Rx9p	V-by-One HS Data Lane 9		27	NC	NO CONNECTION
7	GND	Ground		28	NC	NO CONNECTION
8	Rx10n	V-by-One HS Data Lane 10		29	NC	NO CONNECTION
9	Rx10p	V-by-One HS Data Lane 10		30	NC	NO CONNECTION
10	GND	Ground		31	NC	NO CONNECTION
11	Rx11n	V-by-One HS Data Lane 11		32	NC	NO CONNECTION
12	Rx11p	V-by-One HS Data Lane 11		33	NC	NO CONNECTION
13	GND	Ground		34	NC	NO CONNECTION
14	Rx12n	V-by-One HS Data Lane 12		35	NC	NO CONNECTION
15	Rx12p	V-by-One HS Data Lane 12		36	NC	NO CONNECTION
16	GND	Ground		37	NC	NO CONNECTION
17	Rx13n	V-by-One HS Data Lane 13		38	NC	NO CONNECTION
18	Rx13p	V-by-One HS Data Lane 13		39	NC	NO CONNECTION
19	GND	Ground		40	NC	NO CONNECTION
20	Rx14n	V-by-One HS Data Lane 14		41	NC	NO CONNECTION
21	Rx14p	V-by-One HS Data Lane 14		-		

Table 4-3. MODULE CONNECTOR(CN3) PIN CONFIGURATION

notes : 1. All GND (ground) pins should be connected together to the LCD module's metal frame. 2. #26~#41 NC (No Connection) : These pins are used only for LGD (Do not connect)



Rear view of LCM

3-2-2. Backlight Module

Master

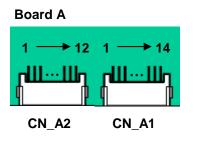
- -LED Driver Connector
- : 20022WR H14B2(Yeonho) or compatible, 20022WR-H12B2(Yeonho) or compatible
- Mating Connector
 - : 20022HS-H14B2(Yeonho) or compatible, 20022HS-H12B2(Yeonho) or compatible

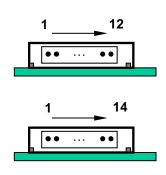
Table 5-1. LED DRIVER CONNECTOR PIN CONFIGURATION

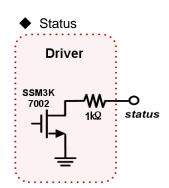
Pin No	Symbol	Description (CN_A1)	Description (CN_A2)	Note
1	VBL	Power Supply +24.0V	Power Supply +24.0V	
2	VBL	Power Supply +24.0V	Power Supply +24.0V	
3	VBL	Power Supply +24.0V	Power Supply +24.0V	
4	VBL	Power Supply +24.0V	Power Supply +24.0V	
5	VBL	Power Supply +24.0V	Power Supply +24.0V	
6	GND	Backlight Ground	Backlight Ground	
7	GND	Backlight Ground	Backlight Ground]
8	GND	Backlight Ground	Backlight Ground	1
9	GND	Backlight Ground	Backlight Ground	7
10	GND	Backlight Ground	Backlight Ground	7
11	Status	Backlight Status	Don't care	2
12	VON/OFF	Backlight ON/OFF control	Don't care	
13	NC	Don't care		
14	EXTVBR_B	External PWM		3

notes : 1. GND should be connected to the LCD module's metal frame.

- 2. Normal : Low (under 0.7V) / Abnormal : Open
- 3. High : on duty / Low : off duty, Pin#14 can be opened. (if Pin #14 is open , EXTVBR-B is 100%)
- 4. Each impedance of pin #12 and 14 is over 50 $[\mbox{K}\Omega]$.
- Rear view of LCM







3-3. Signal Timing Specifications

Table 6 shows the signal timing required at the input of the LVDS transmitter. All of the interface signal timings should be satisfied with the following specification for normal operation.

ITE	M	Symbol	Min	Тур	Max	Unit	Note
	Display Period	tн∨	240	240	240	t clк	3840/16
Horizontal	Blank	tнв	25	35	60	t clk	1
	Total	t HP	265	275	300	t clk	
	Display Period	t∨∨	2160	2160	2160	Lines	
Vertical	Blank	t∨в	40	90	600	Lines	1
	Total	t∨P	2200	2250	2760	Lines	
170	- N 4	O maked	N 4im	Τ	Nam	1.1	Nata
ITE	:IVI	Symbol	Min	Тур	Max	Unit	Note
	DCLK	fсlк	67	74.25	78.00	MHz	1188/16
Frequency	Horizontal	fн	244	270	280	KHz	1
	Vertical	f∨	95	120	122	Hz	2

Table 6. TIMING TABLE (DE Only Mode)

- notes: 1. The input of HSYNC & VSYNC signal does not have an effect on normal operation (DE Only Mode). If you use spread spectrum of EMI, add some additional clock to minimum value for clock margin.
 - 2. The performance of the electro-optical characteristics may be influenced by variance of the vertical refresh rate and the horizontal frequency
 - 3. Spread Spectrum Rate (SSR) is limited to $\,\pm\,$ 0.5% center spread at 30KHz
 - * Timing should be set based on clock frequency.

3-4. V by One input signal Characteristics

3-4-1. V by One Input Signal Timing Diagram

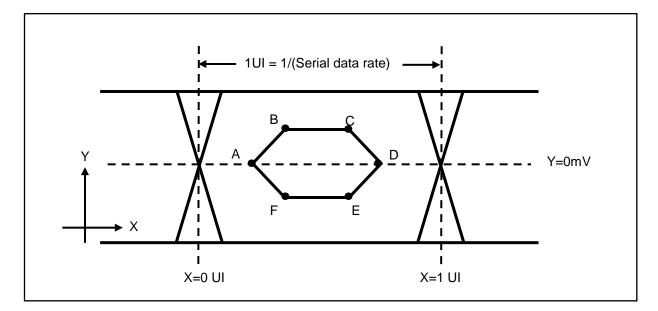


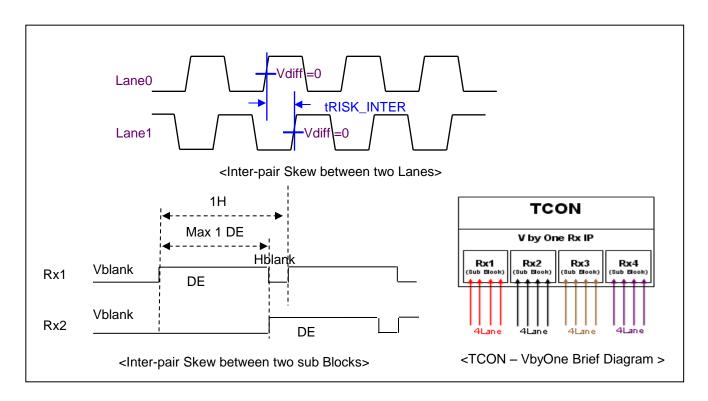
Table7. Eye Mask Specification

	X[UI]	Note	Y[mV]	Note
A	0.25 (max)	2	0	-
В	0.3 (max)	2	50	3
С	0.7(min)	3	50	3
D	0.75(min)	3	0	-
E	0.7(min)	3	I -50 I	3
F	0.3(max)	2	I -50 I	3

notes 1. All Input levels of V by One signals are based on the V by One HS Standard Ver. 1.4

- 2. This is allowable maximum value.
- 3. This is allowable minimum value.
- 4. The eye diagram is measured by the oscilloscope and receiver CDR characteristic must be emulated.
 - PLL bandwidth : 15 Mhz
 - Damping Factor : 1.0

3-4-2. V by One Input Signal Characteristics



Description	Symbol	Min	Мах	Unit	notes
Allowable inter-pair skew between lanes	tRISK_INTER	-	5	UI	1,3
Allowable iner-pair skew between sub-blocks	tRISK_BLOCK	-	1	DE	1,4

Notes 1.1UI = 1/serial data rate

- 2. it is the time difference between the true and complementary single-ended signals.
- 3. it is the time difference of the differential voltage between any two lanes in one sub block.
- 4. it is the time difference of the differential voltage between any two blocks in one IP.

3-5. Color Data Reference

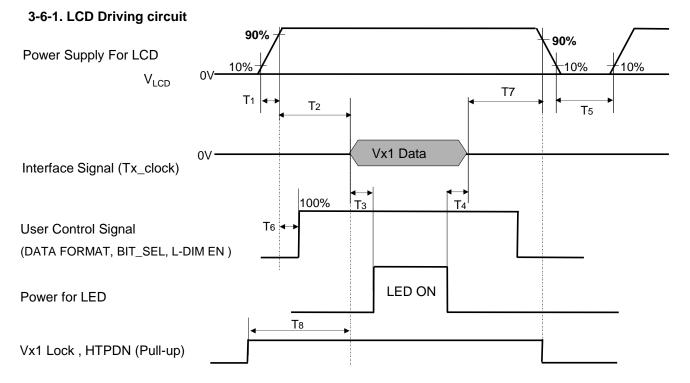
The brightness of each primary color (red, green, blue) is based on the 10bit or 8bit gray scale data input for the color. The higher binary input, the brighter the color. Table 8 provides a reference for color versus data input.

Table 8. COLOR DATA REFERENCE

Pack	er input & Unpacker output	30bpp RGB (10bit)	24bpp RGB (8bit)
	D[0]	R[2]	R[0]
[D[1]	R[3]	R[1]
[D[2]	R[4]	R[2]
Byte0	D[3]	R[5]	R[3]
	D[4]	R[6]	R[4]
[D[5]	R[7]	R[5]
	D[6]	R[8]	R[6]
	D[7]	R[9]	R[7]
	D[8]	G[2]	G[0]
	D[9]	G[3]	G[1]
	D[10]	G[4]	G[2]
Duto1	D[11]	G[5]	G[3]
Byte1	D[12]	G[6]	G[4]
	D[13]	G[7]	G[5]
	D[14]	G[8]	G[6]
	D[15]	G[9]	G[7]
	D[16]	B[2]	B[0]
[D[17]	B[3]	B[1]
	D[18]	B[4]	B[2]
Duto 2	D[19]	B[5]	B[3]
Byte2	D[20]	B[6]	B[4]
[D[21]	B[7]	B[5]
[D[22]	B[8]	B[6]
	D[23]	B[9]	B[7]
	D[24]	Don't care	
	D[25]	Don't care	
ĺ	D[26]	B[0]	
Duta2	D[27]	B[1]	
Byte3	D[28]	G[0]	
l İ	D[29]	G[1]	
l Î	D[30]	R[0]	
	D[31]	R[1]	

Notes 1. 30bpp RGB (10bit) is 4 byte mode, otherwise (24bpp RGB) 3byte mode

3-6. Power Sequence

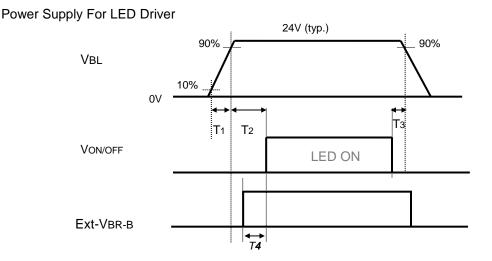


Deremeter		Value		Unit	Nets	
Parameter	Min	Тур	Мах	Unit	Note	
T1	0.5	-	20	ms	1	
T2	200	-	-	ms	2	
Т3	800	-	-	ms	3	
T4	100	-	-	ms	3	
T5	1.0	-	-	S	4	
T6	0	-	T2	ms	5	
T7	0	-	-	ms	6	
Т8	0	-	-	ms		

Note: 1. Even though T1 is over the specified value, there is no problem if I2T spec of fuse is satisfied.

- 2. If T2 is satisfied with specification after removing LVDS Cable, there is no problem.
- 3. The T3 / T4 is recommended value, the case when failed to meet a minimum specification, abnormal display would be shown. There is no reliability problem.
- 4. T5 should be measured after the Module has been fully discharged between power off and on period.
- If the on time of signals (Interface signal and user control signals) precedes the on time of Power (V_{LCD}), it will be happened abnormal display. When T6 is NC status, T6 doesn't need to be measured.
- 6. It is recommendation specification that T7 has to be 0ms as a minimum value.
- * Please avoid floating state of interface signal at invalid period.
- When the power supply for LCD (VLCD) is off, be sure to pull down the valid and invalid data to 0V.

3-6-2. Sequence for LED Driver



3-6-3. Dip condition for LED Driver

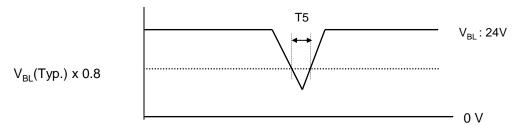


Table 10. Power Sequence for LED Driver

Deremeter	Values			Linita	Demorika
Parameter	Min	Тур	Max	Units	Remarks
T1	20	-	-	ms	1
T2	500	-	-	ms	
Т3	10		-	ms	
T4	0	-	-	ms	
T5	-	-	10	ms	V _{BL} (Typ) x 0.8

notes : 1. T1 describes rising time of 0V to 24V and this parameter does not applied at restarting time. Even though T1 is over the specified value, there is no problem if I²T spec of fuse is satisfied.

4. Optical Specification

Optical characteristics are determined after the unit has been 'ON' and stable in a dark environment at 25±2°C. The values are specified at distance 50cm from the LCD surface at a viewing angle of Φ and θ equal to 0°. FIG. 1 shows additional information concerning the measurement equipment and method.

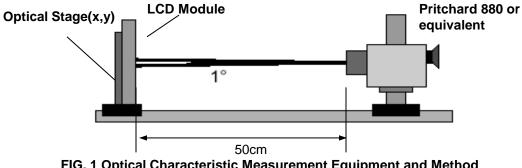


FIG. 1 Optical Characteristic Measurement Equipment and Method

Table 11. OPTICAL CHARACTERISTICS	Table 11.	CHARACTERISTICS
-----------------------------------	-----------	-----------------

Ta= $25\pm2^{\circ}C$, V_{LCD}=12.0V, fv=120Hz, Dclk=74.25MHz,

Parameter		Cu m	hal		Value		Linit	notoo
		Symbol		Min	Тур	Max	Unit	notes
Contrast Ratio		CR		900	1200	-		1
Surface Luminan	ce, white	L _{WH}	L _{WH} -		650		cd/m ²	2
Luminance Variation		δ_{WHITE}	9P	60	-		%	3
Deenenee Time	Gray-to-Gray	G to G δ _{G TO G}		-	8	12	ms	4
Response Time	Uniformity			-	-	1		4
	RED	Rx			0.648			
	RED	Ry	Ry		0.332			
	GREEN	Gx Gy			0.309			
Color Coordinates	S			Тур	0.604	Тур		
	BLUE	B	Bx		0.153	+0.03		
	BLUE	Ву			0.053			
	WHITE	W	Wx		0.279			
	WHITE		Wy		0.292			
Color Temperatur	e				10,000		К	
Color Gamut (ITSC)				72		%	
Viewing Angle (C	R>10)							
x axis	, right(φ=0°)	θr (x a	axis)	89	-	-		
x axis	s, left (φ=180°)	өl (х а	axis)	89	-	-		_
y axis	s, up (φ=90°)	θи (у а	axis)	89	-	-	degree	5
y axis	s, down (φ=270°)	θd (y a	axis)	89	-	-		
Gray Scale				-	-	-		6

EXTVBR-B =100%

notes : 1. Contrast Ratio(CR) is defined mathematically as :

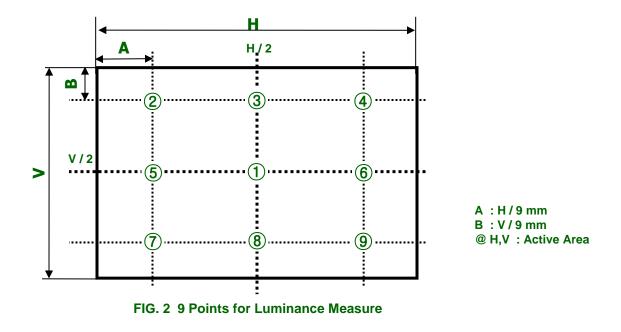
Contrast Ratio = Surface Luminance with all white pixels Surface Luminance with all black pixels It is measured at center 1-point.

- Optical Characteristics is determined after the unit has been 'ON' and 1 Hour after lighting the backlight in a dark environment at 25±2°C. Surface luminance is the luminance value at center 1-point across the LCD surface 50cm from the surface with all pixels displaying white. For more information see the FIG. 2
- The variation in surface luminance, δ WHITE is defined as : WHITE(9P) = Minimum (Lon1,Lon2~ Lon8, Lon9) / Maximum (Lon1,Lon2~ Lon8, Lon9)*100 Where Lon1 to Lon9 are the luminance with all pixels displaying white at 9 locations For more information, see the FIG. 2.
- 4. Response time is the time required for the display to transit from G(N) to G(M) (Rise Time, Tr_R) and from G(M) to G(N) (Decay Time, Tr_D). For additional information see the FIG. 3. (N<M)
 ※ G to G Spec stands for average value of all measured points.
 - Photo Detector : RD-80S / Field : 2°
 - *. Gray to Gray Response time uniformity is Reference data. Appendix V
- 5. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD module surface. For more information, see the FIG. 5.
- 6. Gray scale specification Gamma Value is approximately 2.2. For more information, see the Table 12.

Gray Level	Luminance [%] (Typ)
LO	0.083
L63	0.27
L127	1.04
L191	2.49
L255	4.68
L319	7.66
L383	11.5
L447	16.1
L511	21.6
L575	28.1
L639	35.4
L703	43.7
L767	53.0
L831	63.2
L895	74.5
L959	86.7
L1023	100

Table 12. GRAY SCALE SPECIFICATION

Measuring point for surface luminance & measuring point for luminance variation.



Response time is defined as the following figure and shall be measured by switching the input signal for "Gray(N)" and "Gray(M)".

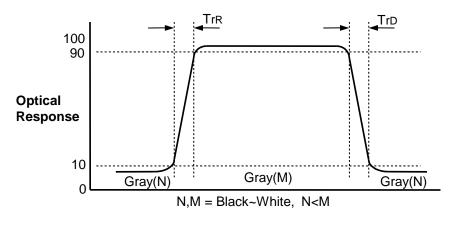
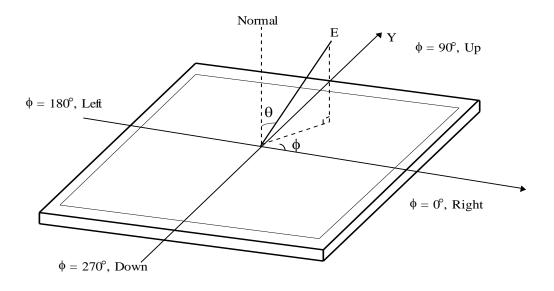


FIG. 3 Response Time

Dimension of viewing angle range





5. Mechanical Characteristics

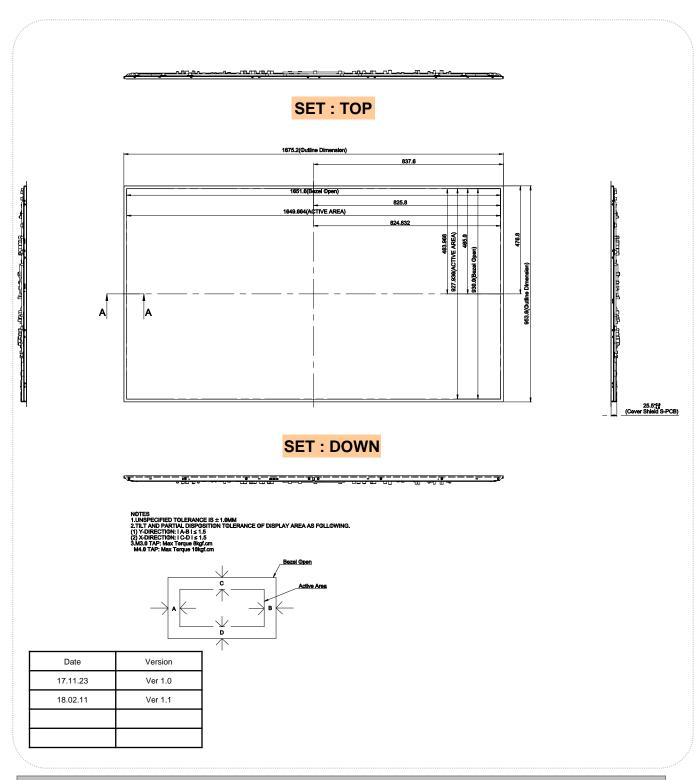
Table 13 provides general mechanical characteristics.

Table 13. MECHANICAL CHARACTERISTICS

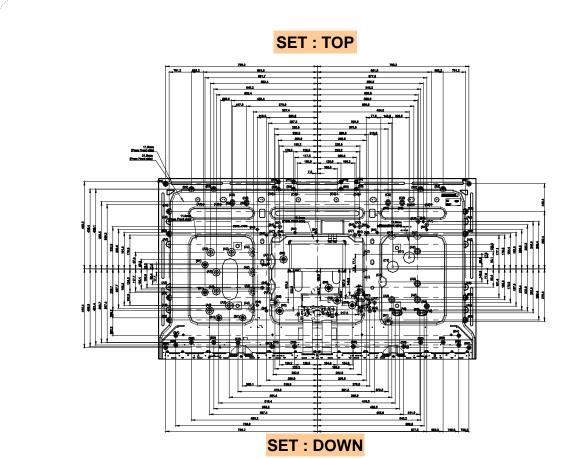
Item	Value				
	Horizontal	1675.2mm			
Outline Dimension	Vertical	953.6 mm			
	Depth	11.9 mm			
Derel Area	Horizontal	1561.6.0 mm			
Bezel Area	Vertical	930. mm			
Active Display Area	Horizontal	1649.664mm			
Active Display Area	Vertical	927.936mm			
Weight	33.1 Kg (Typ.), 36.4 Kg(Max)				

notes : Please refer to a mechanical drawing in terms of tolerance at the next page.

[FRONT VIEW]



[REAR VIEW]



TEM NO.	DESCRIPTION	TYPE	UDM Height (mm)	Max Depth (mm)	Terque (kaf.cm)
(A1)	M3	TAP	12.4	12.4	MAX 8.0
(A2)	M3	TAP	25.9	25.9	MAX 8.0
(A3)	M3	TAP	22.4	22.4	MAX 8.0
(A4)	M3	TAP	25.9(27.1)	25.9	MAX 8.0
(A5)	M3	TAP	13.6	13.6	MAX 8.0
(Aß)	M3	TAP	9.0(10.9)	9.0	MAX 8.0
(A7)	M3	TAP	12.75(13.95)	12.75	MAX 8.0
(AB)	M3	TAP	14.9(16.1)	14.9	MAX 8.0
(B1)	M4	TAP	17.0	8.0	MAX 10.0
(B2)	M4	TAP	13.6	11.0	MAX 10.0
(B3)	M4	TAP	10.7	8.0	MAX 10.0
(B4)	M4	TAP	12.75	11.0	MAX 10.0
(B5)	M4	TAP	21.45	11.0	MAX 10.0
(B6)	M4	TAP	22.45	11.0	MAX 10.0
(B7)	M4	TAP	7.5	7.5	MAX 10.0
(B8)	M4	TAP	14.9	11.0	MAX 10.0
(B9)	M4	TAP	5.0	5.0	MAX 10.0
(BA)	M4	TAP	3.6	3.6	MAX 10.0
(BB)	M4	TAP	4.8	4.8	MAX 10.0
(BC)	M4	TAP	4.7	4.7	MAX 10.0
(BD)	M4	TAP	12.4(13.6)	12.4	MAX 10.0
(C1)	Ø10.0	EMBO	14.5		
(C2)	Ø12.0	EMBO	4.5		
(C3)	Ø4.0	EMBO	1.5		
(C4)	Ø5.0	EMBØ	2.0		
(C5)	Ø4.0	EMBØ	1.2		

6. Reliability

Table 14. ENVIRONMENT TEST CONDITION

No.	Test Item	Condition				
1	High temperature storage test	Ta= 60°C 90% 240h				
2	Low temperature storage test	Ta= -20°C 240h				
3	High temperature operation test	Ta= 50°C 50%RH 500h				
4	Low temperature operation test	Ta= 0°C 500h				
5	Humidity condition Operation	Ta= 40 °C ,90%RH				
6	Altitude operating storage / shipment	0 - 16,400 ft 0 - 40,000 ft				

Note : 1. Before and after Reliability test, LCM should be operated with normal function.

2. These conditions are for LGD's internal test. Please refer to Absolute Maximum Ratings (Table1) for guaranteed condition.

7. International Standards

7-1. Safety

- a) UL 60065, Underwriters Laboratories Inc. Audio, Video and Similar Electronic Apparatus - Safety Requirements.
- b) CAN/CSA C22.2 No.60065:03, Canadian Standards Association. Audio, Video and Similar Electronic Apparatus - Safety Requirements.
- c) EN 60065, European Committee for Electrotechnical Standardization (CENELEC). Audio, Video and Similar Electronic Apparatus - Safety Requirements.
- d) IEC 60065, The International Electrotechnical Commission (IEC). Audio, Video and Similar Electronic Apparatus - Safety Requirements.

7-2. Environment

a) RoHS, Directive 2011/65/EU of the European Parliament and of the council of 8 June 2011

8. Packing

8-1. Information of LCM Label

a) Lot Mark



A,B,C : SIZE(INCH) E : MONTH D : YEAR F ~ M : SERIAL NO.

Note

1. YEAR

Year	2011	2012	2013	2014	2015	2016	2017	2018	2019	2020
Mark	А	В	С	D	E	F	G	Н	J	К

2. MONTH

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Mark	1	2	3	4	5	6	7	8	9	А	В	С

b) Location of Lot Mark

Serial NO. is printed on the label. The label is attached to the backside of the LCD module. This is subject to change without prior notice.

8-2. Packing Form

- a) Package quantity in one Pallet : 8 pcs
- b) Pallet Size : 1910 mm(W) X 760 mm(D) X 1310 mm(H)

9. Precautions

Please pay attention to the followings when you use this TFT LCD module.

9-1. Mounting Precautions

- (1) You must mount a module using specified mounting holes (Details refer to the drawings).
- (2) You should consider the mounting structure so that uneven force (ex. Twisted stress, Concentrated stress) is not applied to the module. And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.
- (3) Please attach the surface transparent protective plate to the surface in order to protect the polarizer. Transparent protective plate should have sufficient strength in order to the resist external force.
- (4) You should adopt radiation structure to satisfy the temperature specification.
- (5) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter causes circuit break by electro-chemical reaction.
- (6) Do not touch, push or rub the exposed polarizers with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of polarizer for bare hand or greasy cloth.(Some cosmetics are detrimental to the polarizer.)
- (7) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzine. Normal-hexane is recommended for cleaning the adhesives used to attach front / rear polarizers. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer
- (8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.
- (9) Do not open the case because inside circuits do not have sufficient strength.
- (10) Touching the LED Driver might cause an electric shock and damage to LED Driver. Please always use antistatic tools when handling the LED Driver

9-2. Operating Precautions

- (1) Response time depends on the temperature.(In lower temperature, it becomes longer.)
- (2) Brightness depends on the temperature. (In lower temperature, it becomes lower.) And in lower temperature, response time(required time that brightness is stable after turned on) becomes longer
- (3) Be careful for condensation at sudden temperature change.Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
- (4) When fixed patterns are displayed for a long time, remnant image is likely to occur.
- (5) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference shall be done by system manufacturers. Grounding and shielding methods may be important to minimized the interference.
- (6) Please do not give any mechanical and/or acoustical impact to LCM. Otherwise, LCM can't be operated its full characteristics perfectly.
- (7) A screw which is fastened up the steels should be a machine screw. (if not, it can causes conductive particles and deal LCM a fatal blow)
- (8) Please do not set LCD on its edge.
- (9) The conductive material and signal cables are kept away from LED driver inductor to prevent abnormal display, sound noise and temperature rising.

9-3. Electrostatic Discharge Control

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wrist band etc. And don't touch interface pin directly.

9-4. Precautions for Strong Light Exposure

Strong light exposure causes degradation of polarizer and color filter.

9-5. Storage

When storing modules as spares for a long time, the following precautions are necessary.

- (1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.
- (2) The polarizer surface should not come in contact with any other object.
- It is recommended that they be stored in the container in which they were shipped.
- (3) Storage condition is guaranteed under packing conditions.
- (4) The phase transition of Liquid Crystal in the condition of the low or high storage temperature will be recovered when the LCD module returns to the normal condition.

9-6. Handling Precautions for Protection Film

(1) The protection film is attached to the bezel with a small masking tape. When the protection film is peeled off, static electricity is generated between the film and polarizer. This should be peeled off clowly and carefully by peeple who are electrically grounded and with a

This should be peeled off slowly and carefully by people who are electrically grounded and with well ionblown equipment or in such a condition, etc.

- (2) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the bezel after the protection film is peeled off.
- (3) You can remove the glue easily. When the glue remains on the bezel surface or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material like chamois soaked with normalhexane.

9-7. Appropriate Condition for Commercial Display

Generally large-sized LCD modules are designed for consumer applications (TV).
 Accordingly, a long-term display like in Commercial Display application, can cause uneven display including image sticking. To optimize module's lifetime and function, several operating usages are required.

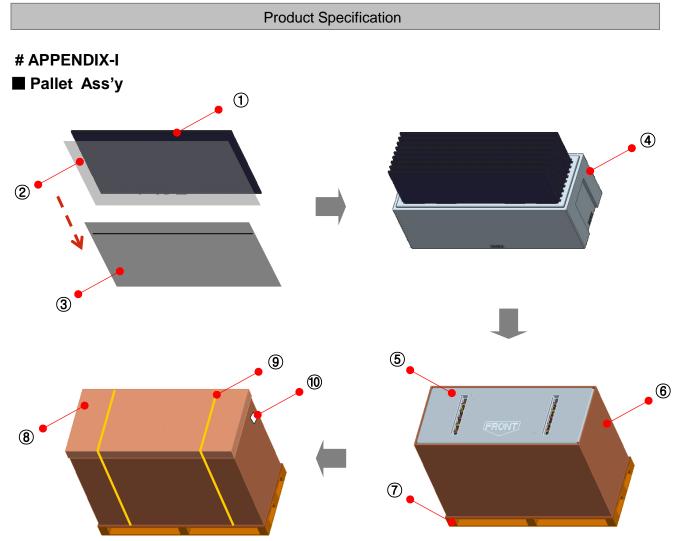
- 1. Normal operating condition
 - Temperature: 0 ~ 40 °C
 - Operating Ambient Humidity : 10 ~ 90 %
 - Display pattern: dynamic pattern (Real display)

Note) Long-term static display can cause image sticking.

- 2. Operating usages under abnormal condition
- a. Ambient condition
 - Well-ventilated place is recommended to set up Commercial Display system.
- b. Power and screen save
 - Periodical power-off or screen save is needed after long-term display.
- 3. Operating usages to protect against image sticking due to long-term static display
- a. Suitable operating time: under 24 hours a day.
- b. Static information display recommended to use with moving image.
- Cycling display between 5 minutes' information(static) display and 10 seconds' moving image.
- c. Background and character (image) color change
- Use different colors for background and character, respectively.
- Change colors themselves periodically.
- d. Avoid combination of background and character with large different luminance.
- 1) Abnormal condition just means conditions except normal condition.
- 2) Black image or moving image is strongly recommended as a screen save.

4. Lifetime in this spec. is guaranteed only when Commercial Display is used according to operating usages.

5. Module should be turned clockwise based on front view when used in portrait mode.



No.	Description	Material
1	LCM	-
2	Protect Film	PET
3	Bag	AI
4	Bottom Packing	EPS
5	Top Packing	EPS
6	Angle Packing	Paper
7	Pallet	Plywood
8	Angle Cover	Paper
9	Band	PP
10	Label	Yupo Paper 100x70

APPENDIX- II-1 LCM Label

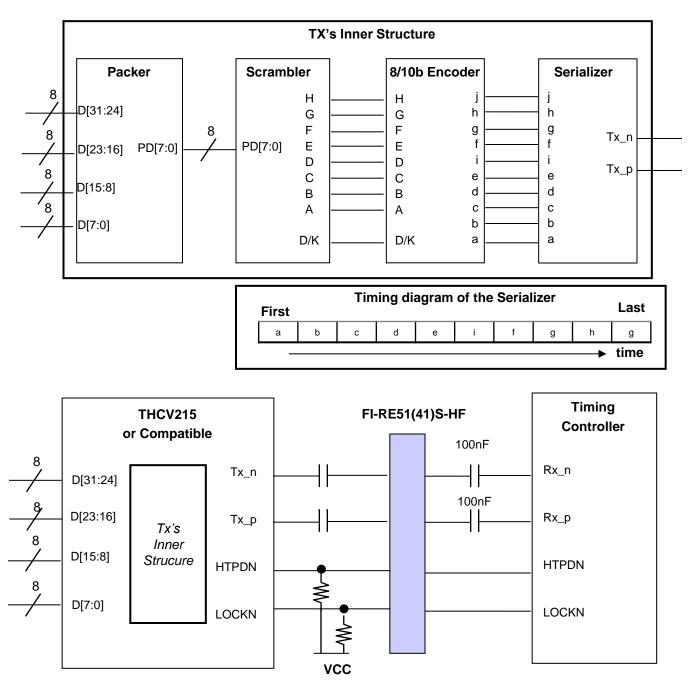


APPENDIX- II-2



APPENDIX- III

Required signal assignment for Flat Link (Thine : THCV215) Transmitter



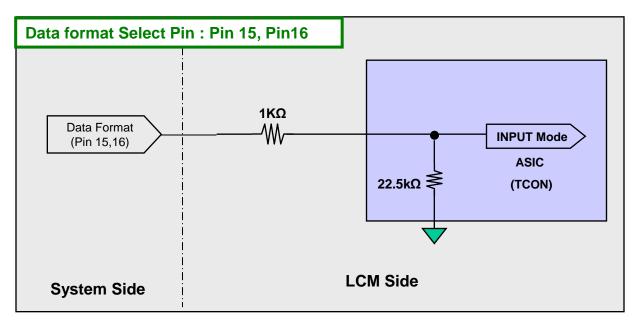
notes: 1. The LCD module uses a 100 nF capacitor on positive and negative lines of each receiver input.

- 2. Refer to Vx1 Transmitter Data Sheet for detail descriptions. (THCV215 or Compatible)
- 3. About Module connector pin configuration, Please refer to the Page 8~9.

APPENDIX- IV-1

Option Pin Circuit Block Diagram

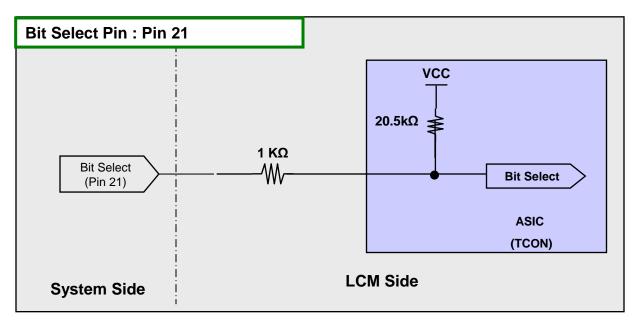
1) Circuit Block Diagram of Data format Selection pin



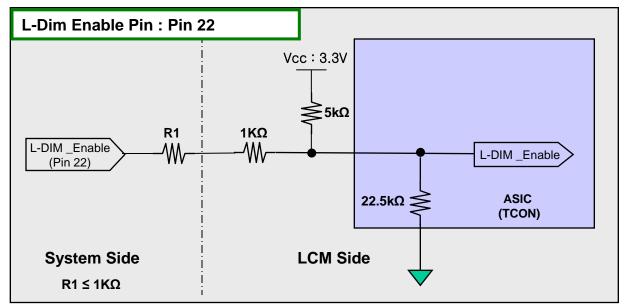
APPENDIX- IV-3

Option Pin Circuit Block Diagram

2) Circuit Block Diagram of Bit Selection pin



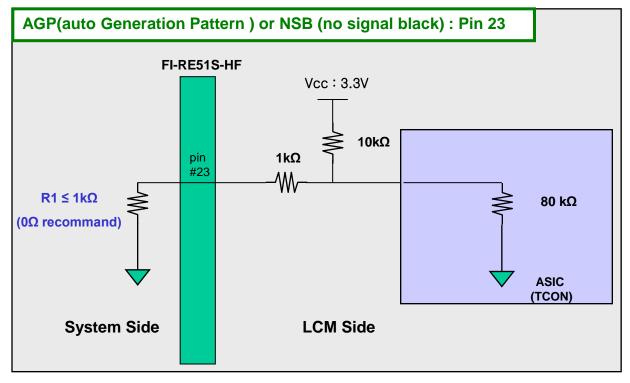
3) Circuit Block Diagram of L-Dim Enable Selection pin



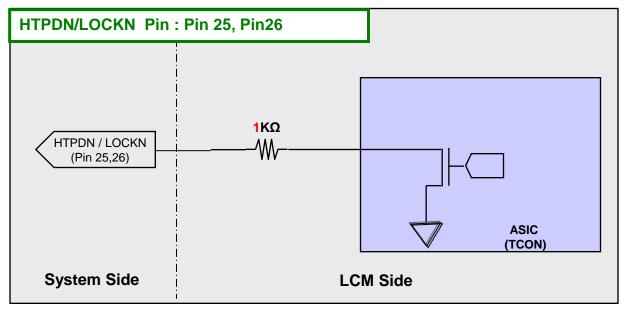
APPENDIX- IV-4

Option Pin Circuit Block Diagram

4) Circuit Block Diagram of AGP Selection pin



5) Circuit Block Diagram of HTPDN/ LOCKN Selection pin



APPENDIX- V

Gray to Gray Response Time Uniformity

This is only the reference data of G to G and uniformity for LD750EQD-FLM1 model.

1. G to G Response Time :

Response time is defined as Figure3 and shall be measured by switching the input signal for "Gray (N)" and "Gray(M)".(32Gray Step at 8bit)

2. G to G Uniformity

The variation of G to G Uniformity , δ G to G is defined as :

G to G Uniformity = $\frac{Maximum(GtoG) - Typical(GtoG)}{Typical(GtoG)} \leq 1$

*Maximum (G to G) means maximum value of measured time (N, M = 0 (Black) ~ 1023(White), 128 gray step).

	0Gray	127ray	255Gray	 895Gray	1023Gray
0Gray		TrR:0G→127G	TrR:0G→255G	 TrR:0G→895G	TrR:0G→1023G
127Gray	TrD:127G→0G		TrR:127G→255G	 TrR:127G→895G	TrR:127G→1023G
255Gray	TrD:255G→0G	TrD:255G→127G		 TrR:255G→895G	TrR:255G→1023G
895Gray	TrD:895G→0G	TrD:895G→127G	TrD:895G→255G		TrR:895G→1023G
1023Gray	TrD:1023G → 0G	TrD:1023G→127G	TrD:1023G→255G	 TrD:1023G→895G	

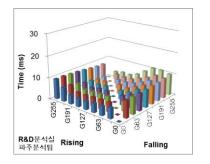
3. Sampling Size : 2 pcs

4. Measurement Method : Follow the same rule as optical characteristics measurement.

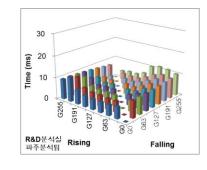
5. Current Status

Below table is actual data of production on Oct. 23. 2015 (LGD RV Event Sample)

	G to G Respo	Uniformity	
	Min.	Max.	Ofmorning
# 1	3.6	10.9	0.81
# 2	4.3	11.5	0.91



< # 1 >



APPENDIX- VI-1

■ input mode of pixel data

N	1 : Non	-Division		Mod	e 2 : 2	Division	
	2						
	1st Data	2nd Data	Data #		1st Data	2nd Data	Data #
Lane00	1	17	3825	Lane00	1	9	1913
Lane01	2	18	3826	Lane01	2	10	1914
Lane02	3	19	3827	Lane02	3	11	1915
Lane03	4	20	3828	Lane03	4	12	1916
Lane04	5	21	3829	Lane04	5	13	1917
Lane05	6	22	3830	Lane05	6	14	1918
Lane06	7	23	3831	Lane06	7	15	1919
Lane07	8	24	3832	Lane07	8	16	1920
	1st Data	2nd Data	Data #		1st Data	2nd Data	Data #
Lane08	9	25	3833	Lane08	1921	1929	3833
Lane09	10	26	3834	Lane09	1922	1930	3834
Lane 10	11	27	3835	Lane 10	1923	1931	3835
Lane11	12	28	3836	Lane11	1924	1932	3836
Lane 12	13	29	3837	Lane 12	1925	1933	3837
Lane 13	14	30	3838	Lane 13	1926	1934	3838
Latory						1005	0000
Lane 14	15	31	3839	Lane 14	1927	1935	3839

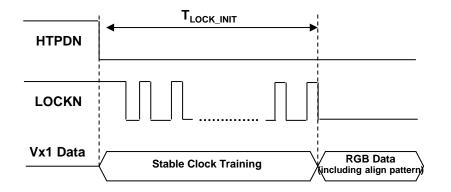
APPENDIX- VI-2

■ input mode of pixel data

Mode 3 : 4 Division	Mode 4 : 8 Division					
1st Data 2nd Data Data #	1st Data 2nd Data Data #					
Lane00 1 5 957	Lane00 1 3 479					
Lane01 2 6 958	Lane01 2 4 480					
Lane02 3 7 959	Lane02 481 483 959					
Lane03 4 8 960	Lane03 482 484 960					
Lane04 961 965 1917	Lane04 961 963 1439					
Lane05 962 966 1918	Lane05 962 964 1440					
Lane06 963 967 1919	Lane06 1441 1443 1919					
Lane07 964 968 1920	Lane07 1442 1444 1920					
1st Data 2nd Data Data #	1st Data 2nd Data Data #					
Lane08 1921 1925 2877	Lane08 1921 1923 2399					
Lane09 1922 1926 2878	Lane09 1922 1924 2400					
Lane10 1923 1927 2879	Lane10 2401 2403 2879					
Lane11 1924 1928 2880	Lane11 2402 2404 2880					
Lane12 2881 2885 3837	Lane12 2881 2883 3359					
Lane13 2882 2886 3838	Lane13 2882 2884 3360					
Lane14 2883 2887 3839	Lane14 3361 3363 3839					
Lane15 2884 2888 3840	Lane15 3362 3364 3840					

APPENDIX- VII-1

■ Vx1 Initialization Characteristics

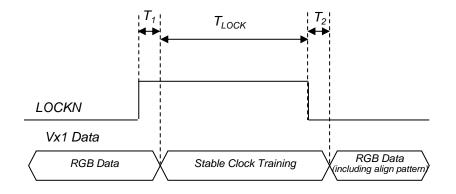


1). UHD120Hz T-Con

Characteristics	Symbol	Min	Тур	Max	Unit
Initial CDR lock time (From Stable CDR training to CDR lock)	T _{LOCK_INT}	0		310	ms

APPENDIX- VII-2

Vx1 Lock Timing In Normal Operation



Characteristics	Symbol	Min	Тур	Max	Unit
CDR lock time from stable clock training pattern to LOCKN "Low" in normal operation	Т _{LOCK}			2	ms
Latency from LOCKN "High" to clock training pattern	T ₁			100	us
Latency from clock "Low" to normal RGB Data	T ₂			100	us

% Vx1 Rx should get clock training pattern in T₁